OSRAM LY Q976.01 **Datasheet**



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Chip LED 0603

LY Q976.01

The Chip LED 0603 is the product of choice for low power status indication in electronics. The small package size allows compact designs, like 7-segment displays, symbol backlighting or button and switch illumination in control panels. The high brightness of the LED ensures good visibility at any time.







Applications

- Appliances & Tools
- Display Backlighting
- Factory Automation

- Home & Building Automation
- Projection & Display
- Static Signaling

Features

- Package: SMT package 0603, clear epoxy
- Chip technology: Volume emitter (InGaAIP)
- Typ. Radiation: 150°
- Color: λ_{dom} = 589 nm (• yellow)
- Corrosion Robustness Class: 2B
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM)

LY Q976.01 DATASHEET



Luminous Intensity 1) Ordering Code Type

I_F = 20 mA

ľ

71 ... 180 mcd LY Q976.01-Q1R2-36-1 Q65113A5258



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T _{op}	min.	-40 °C
	·	max.	85 °C
Storage Temperature	T_{stg}	min.	-40 °C
	3.9	max.	85 °C
Junction Temperature	T _j	max.	95 °C
Forward current	I _F	min.	1 mA
$T_S = 25 ^{\circ}C$	·	max.	30 mA
Forward Current pulsed	 F pulse	max.	50 mA
$t \le 100 \ \mu s; D = 0.03 ; T_s = 25 \ ^{\circ}C$			
Surge Current	l _{FS}	max.	100 mA
$t \le 10 \ \mu s; D = 0.005 ; T_s = 25 \ ^{\circ}C$. 0		
Reverse voltage 2)	V_R	max.	10 V
T _S = 25 °C	IX		
ESD withstand voltage	V_{ESD}		2 kV
acc. to ANSI/ESDA/JEDEC JS-001 (HBM)	200		



Characteristics

 I_F = 20 mA; T_S = 25 °C

Parameter	Symbol		Values
Peak Wavelength	λ_{peak}	typ.	592 nm
Dominant Wavelength 3)	$\lambda_{\sf dom}$	min.	584 nm
	40	typ.	589 nm
		max.	595 nm
Spectral Bandwidth at 50% I _{rel,max}	Δλ	typ.	14 nm
Viewing angle at 50% $\rm I_{\rm v}$	2φ	typ.	140 °
Forward Voltage 4)	V_{F}	min.	1.60 V
$I_F = 20 \text{ mA}$	•	typ.	2.00 V
		max.	2.40 V
Reverse current 2)	I _R	typ.	0.01 μΑ
V _R = 10 V	TX	max.	10 µA
Real thermal resistance junction/solderpoint 5)	R _{thJS real}	typ.	440 K / W
	ulioo real	max.	540 K / W



Brightness Groups

Group	Luminous Intensity 1) I _F = 20 mA	Luminous Intensity. 1) I _F = 20 mA	Luminous Flux ⁶⁾ I _F = 20 mA
	min.	max.	typ.
	l _v	I _v	Φ_{V}
Q1	71 mcd	90 mcd	270 mlm
Q2	90 mcd	112 mcd	340 mlm
R1	112 mcd	140 mcd	430 mlm
R2	140 mcd	180 mcd	540 mlm

Forward Voltage Groups

Group	Forward Voltage ⁴⁾ I _F = 20 mA	Forward Voltage ⁴⁾ I _F = 20 mA		
	min.	max.		
	V_{F}	V_{F}		
A8	1.60 V	2.00 V		
J8	2.00 V	2.40 V		

Wavelength Groups

Group	Dominant Wavelength 3)	Dominant Wavelength 3)
	min.	max.
	λ_{dom}	$\lambda_{\sf dom}$
3	584 nm	587 nm
4	587 nm	590 nm
5	589 nm	592 nm
6	592 nm	595 nm

LY Q976.01 DATASHEET



Group Name on Label

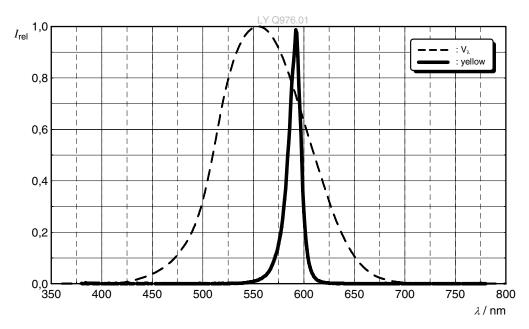
Example: Q1-3-A8

Brightness	Wavelength	Forward Voltage
Q1	3	A8



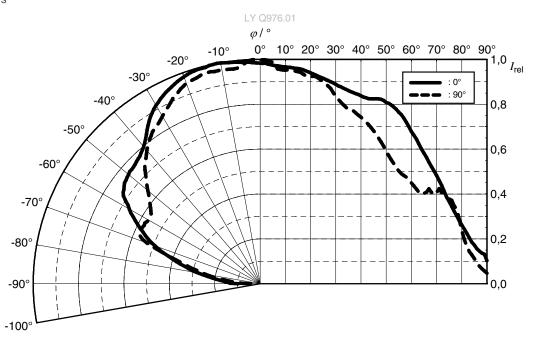
Relative Spectral Emission 6)

$$I_{rel}$$
 = f (λ); I_{F} = 20 mA; T_{S} = 25 °C



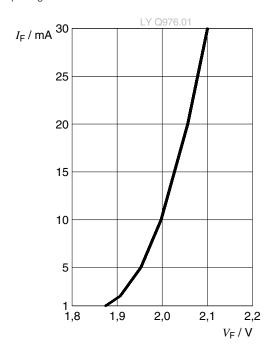
Radiation Characteristics 6)

$$I_{rel} = f(\phi); T_S = 25 °C$$



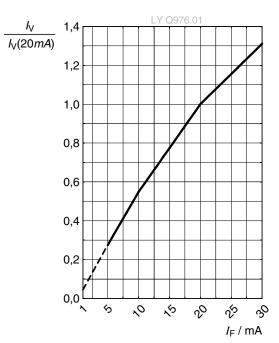
Forward current 6)

$$I_F = f(V_F); T_S = 25 \, ^{\circ}C$$



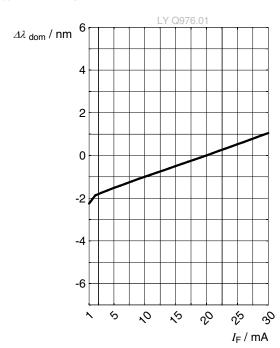
Relative Luminous Intensity 6), 7)

$$I_{v}/I_{v}(20 \text{ mA}) = f(I_{F}); T_{S} = 25 \text{ °C}$$



Dominant Wavelength 6)

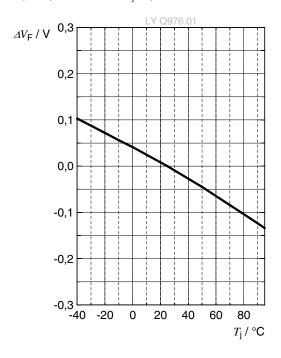
$$\Delta\lambda_{dom} = f(I_F); T_S = 25 \, ^{\circ}C$$





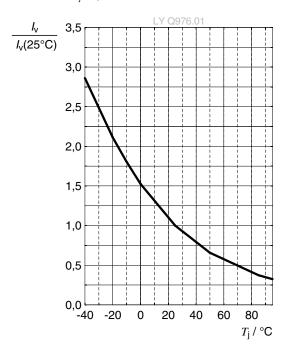
Forward Voltage 6)

$$\Delta V_{_F} = V_{_F} - V_{_F} (25~^{\circ}C) = f(T_{_j}); \ I_{_F} = 20~mA$$



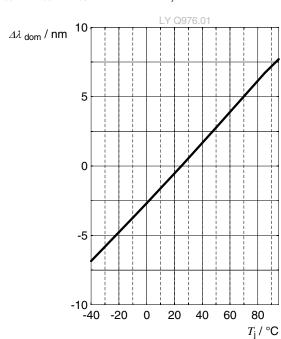
Relative Luminous Intensity 6)

$$I_{v}/I_{v}(25 \text{ °C}) = f(T_{i}); I_{F} = 20 \text{ mA}$$



Dominant Wavelength 6)

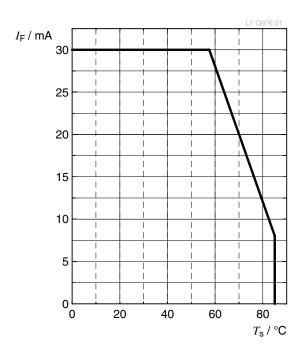
$$\Delta\lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}} (25 \text{ °C}) = f(T_j); I_F = 20 \text{ mA}$$





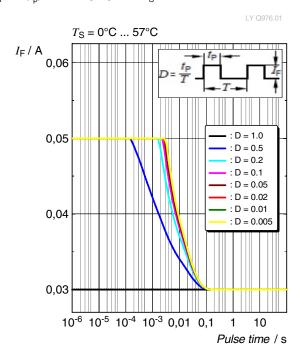
Max. Permissible Forward Current 5)

 $I_{\scriptscriptstyle F} = f(T)$



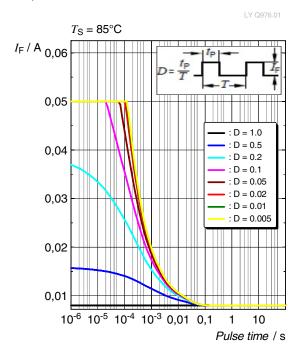
Permissible Pulse Handling Capability

 $I_F = f(t_p)$; D: Duty cycle; $T_S = 25 \,^{\circ}\text{C}$



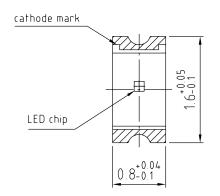
Permissible Pulse Handling Capability

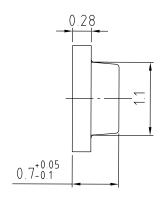
 $I_{_{\rm F}}$ = f(t $_{_{
m D}}$); D: Duty cycle; $T_{_{
m S}}$ = 85 °C

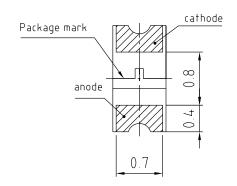




Dimensional Drawing 8)







general tolerance ±0.1

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lead finish Ag

Further Information:

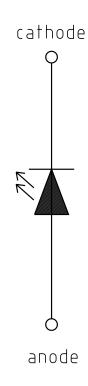
Approximate Weight: 1.4 mg

Corrosion test: Class: 2B

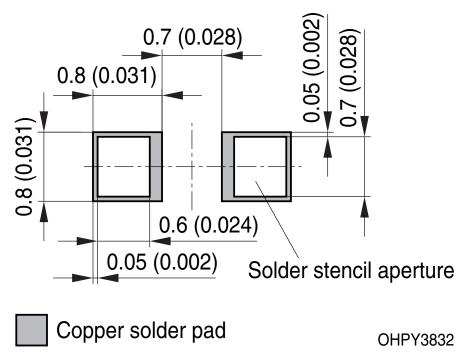
Test condition: 25° C / 75 % RH / 10 ppm H₂S / 21 days (IEC 60068-2-43)



Electrical Internal Circuit



Recommended Solder Pad 8)

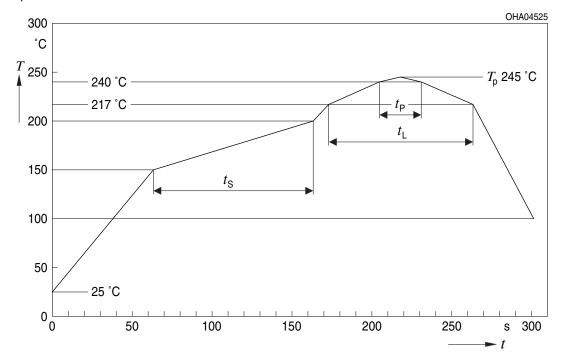


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.



Reflow Soldering Profile

Product complies to MSL Level 3 acc. to JEDEC J-STD-020E



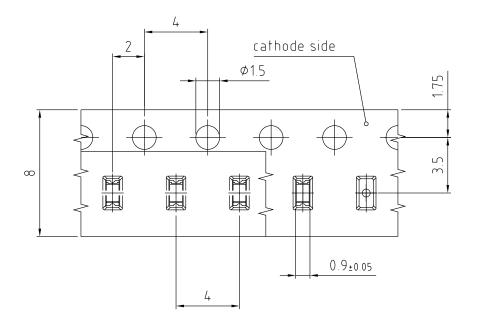
Un	nit
mum	
3 K/s	S
20 s	
3 K/s	S
°C	;
00 s	
°C	
30 s	
6 K/s	S
30 s	
3	30 s 6 K/s

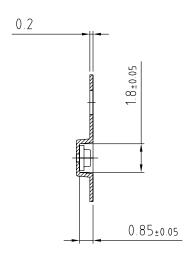
All temperatures refer to the center of the package, measured on the top of the component

^{*} slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



Taping 8)

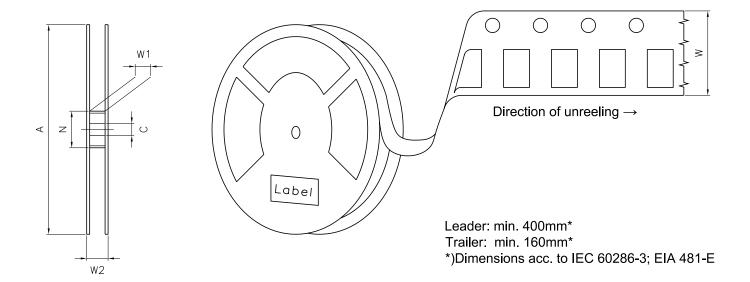




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Tape and Reel 9)

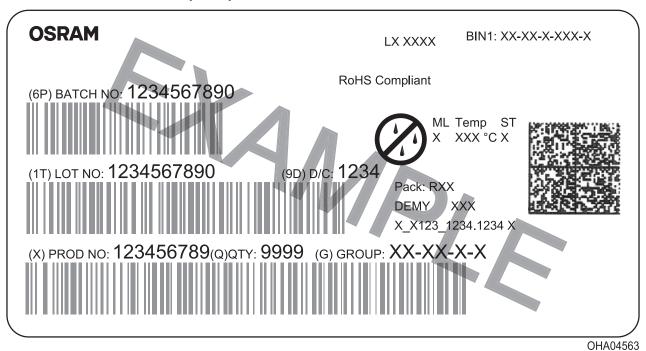


Reel Dimensions

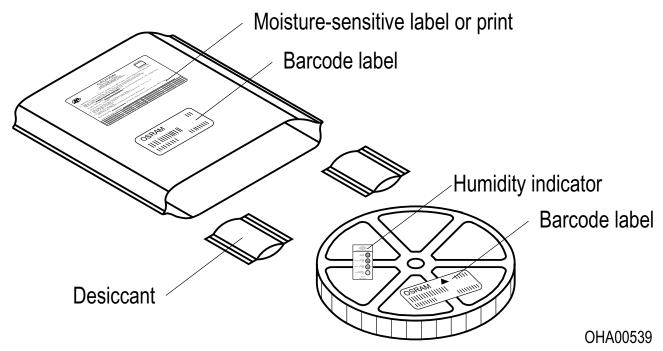
Α	W	N_{\min}	W_1	$W_{2 max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	58 mm	8.4 + 1,5 mm	14.4 mm	4000



Barcode-Product-Label (BPL)



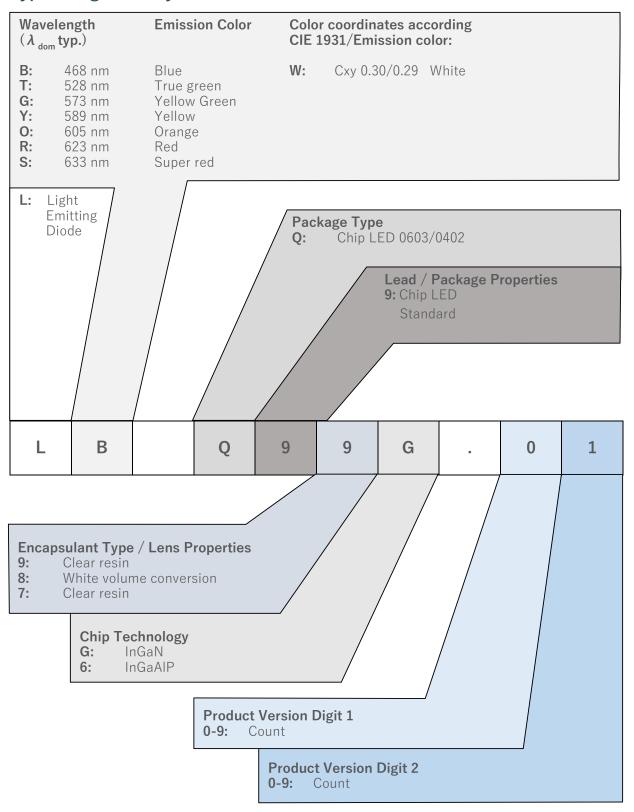
Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Type Designation System



LY Q976.01 **DATASHEET**



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class exempt group (exposure time 10000 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit https://ams-osram.com/support/application-notes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



Glossary

- Brightness: Brightness groups are tested at a current pulse duration of 25 ms and a tolerance of ±11 %.
- 2) Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 3) Wavelength: Wavelengths are tested at a current pulse duration of 25 ms and a tolerance of ±1 nm.
- 4) Forward Voltage: Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of ±0.1 V.
- 5) Thermal Resistance: Rth max is based on statistic values (6 σ) used for Derating.
- 6) Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- 9) Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

LY Q976.01 DATASHEET



Revision History

Version	Date	Change
1.0	2023-02-09	Initial Version
1.1	2023-08-25	Characteristics
1.2	2024-09-05	Description
1.3	2025-07-29	Recommended Solder Pad



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